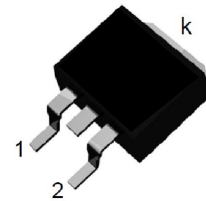


Features

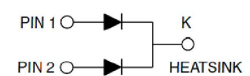
- Plastic package has underwriters Laboratory Flammability Classification 94V-0
- Dual rectifier construction, positive center tap
- Low forward voltage, high efficiency



Package: TO-263 (D²PAK)

Mechanical Data

- Case: epoxy, molded
- Weight: 1.4 grams (approximately)
- Lead temperature for soldering purpose: 260°C max. for 10 sec
- 800 pcs per reel



Schematic Diagram

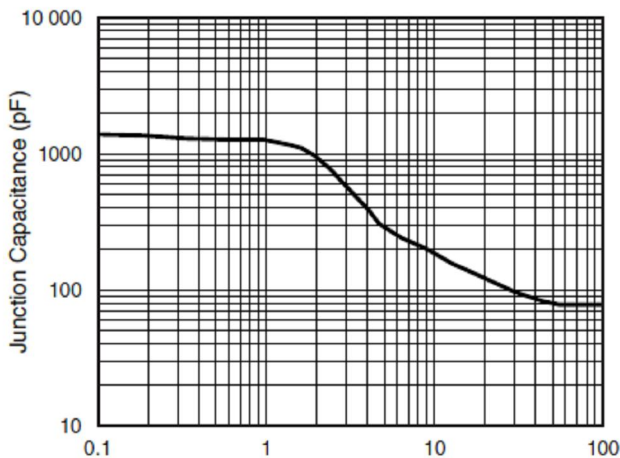
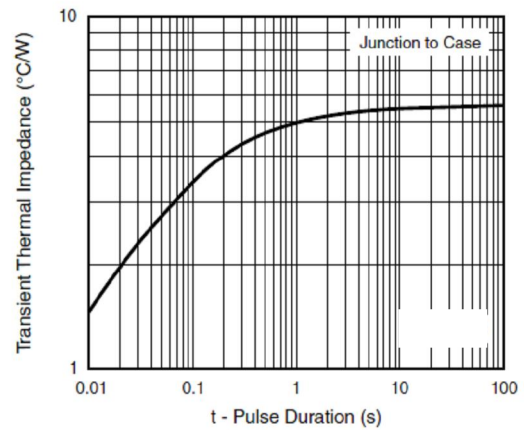
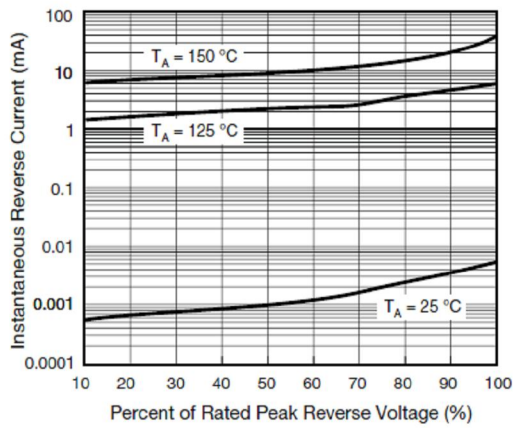
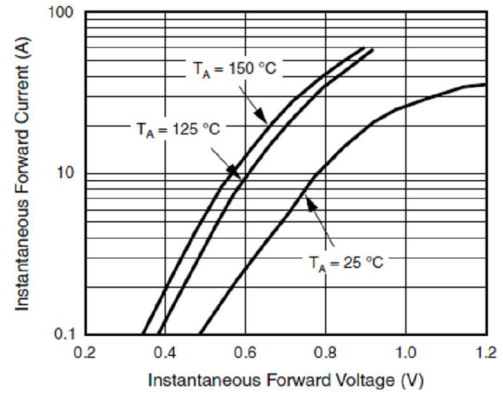
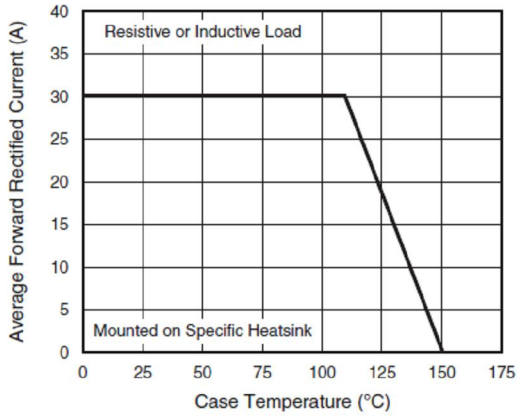
Maximum Ratings & Electrical Characteristics

(T_A=25°C unless otherwise noted)

Parameter	Test Conditions	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage		V _{RRM}	300	V
Working Peak Reverse Voltage		V _{RWM}	300	V
Maximum DC Blocking Voltage		V _{DC}	300	V
Maximum Average Forward Rectified Current @ T _c =105°C	Total Device Per Diode	I _{F(AV)}	30 15	A
Peak Forward Surge Current 8.3ms Single Half Sine-wave Superimposed on Rated Load per Diode		I _{FSM}	200	A
Peak repetitive Reverse Current Per Leg at tp=2.0µs ,1KHz		I _{RRM}	2.0	A
Voltage Rate of Change (rated V _R)		DV/dt	10000	V/µs
Operating Junction Temperature Range		T _J	- 55 to+150	°C
Storage Temperature Range		T _{STG}	- 55 to+150	°C
Maximum Instantaneous Forward Voltage per Leg	I _F =15A T _C =25°C	V _F	0.96	V
	I _F =15A T _C =125°C		0.89	
Maximum Reverse Current per Leg at Working Peak Reverse Voltage	T _J =25°C	I _R	100	µA
	T _J =100°C		10	mA
Thermal Characteristics (T _A =25°C unless otherwise noted)				
Symbol	Parameter	Typ.		Unit
R _{θJC}	Thermal Resistance, Junction to Case per Leg	2.0		°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient per Leg	62.5		°C/W

Note: Pulse test:300us pulse width, duty cycle=2%

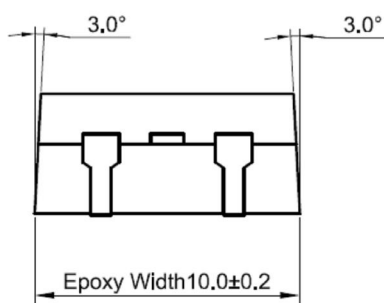
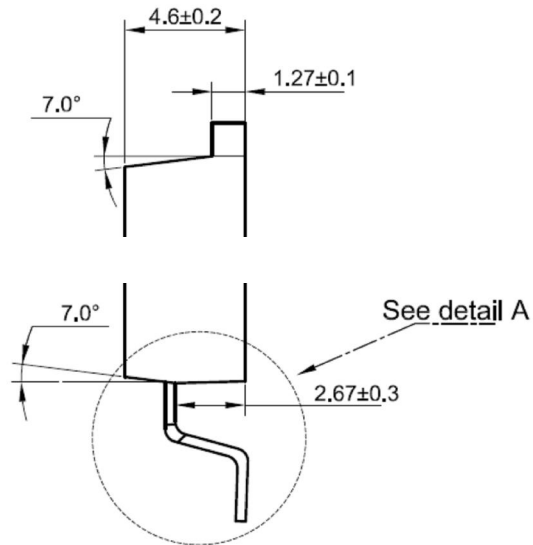
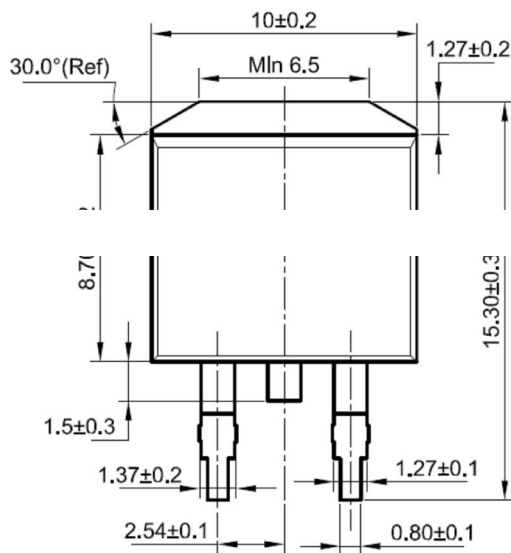
Ratings and Characteristics Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)



Package Outline Dimensions

in millimeters

TO-263 (D²PAK)



Detail A

